

1. Scope

This reference specification applies to Leaded common mode choke coil PLT10HN Series.

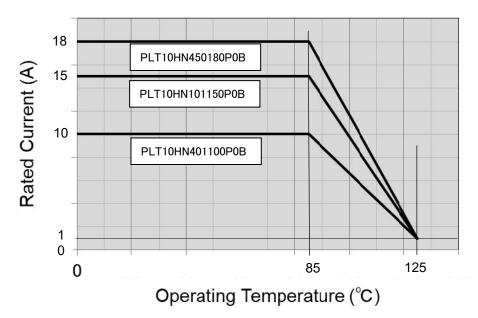
2. Part Numbering

(Ex.) <u>PLT</u>	10H	<u>N</u>	<u>401</u>	100	<u> </u>	<u> </u>	
Product ID	Type	Application	Common Mode	Rated	Winding	Dimenssion Packag	ing
			Impedance Zc	Current	Mode	code	

3. Rating

Customer Part Number	MURATA Part Number	Common Mode Impedance Zc (at10MHz) Typ.	Rated Voltage	Withstand Voltage	* Rated Current	DC Resistance (Rdc)	Insulation Resistance (I.R.)	Inductance (L)
	PLT10HN401100P0B	400Ω	100V (DC)	250V (DC)	10A	$3.6 m\Omega$ $\pm 0.5 m\Omega$	10MΩ min.	6μH min.
	PLT10HN101150P0B	100Ω	300V (DC)	750V (DC)	15A	1.8mΩ ±0.5mΩ	10MΩ min.	2.0µH min.
	PLT10HN450180P0B	45Ω	300V (DC)	750V (DC)	18A	1.3 m Ω ± 0.5 m Ω	10MΩ min.	0.8µH min.

- Operating Temperature range (Product temperature; Self- temperature rise is included) : -55°C∼+125°C
- Storage Temperature range : -55°C~+125°C
- * Rated Current is derated as below figure depending on the operating temperature.



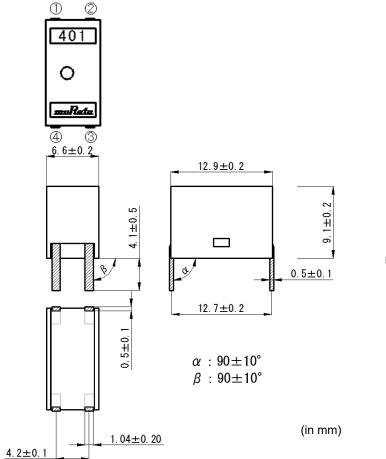
4. Standard Testing Conditions

< Unless otherwise specified > Temperature: Ordinary Temp.15 °C to 35 °C Humidity: Ordinary Humidity 25 %(RH) to 85 %(RH) < In case of doubt >
Temperature: 20 °C ± 2 °C
Humidity: 60 %(RH) to 70 %(RH)
Atmospheric programs: 26 kPa to 10

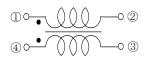
Atmospheric pressure: 86 kPa to 106 kPa

Reference Only





■Equivalent Circuit



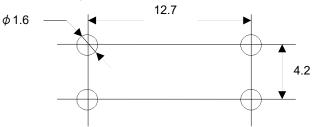
No Polarity

■Unit Mass (Typical value) 2.1g

: Electrode

(in mm)

■Terminal Layout (Bottom Figure)

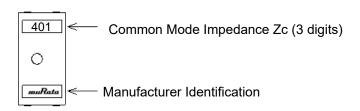


6. Marking

(1)Manufacturer Identification : (**muRata**)

(2)Parts Number: Common Mode Impedance Zc

PLT10HN401100P0B : (**401**) PLT10HN101150P0B : (**101**) PLT10HN450180P0B : (**450**)





7. Electrical Performance

No.	Item	Specification	Test method
7.1	Common Mode Impedance (Zc) Typ.	Meet item 3	Measuring Frequency: 10MHz (ref.item 10) Measuring Equipment: KEYSIGHT 4294A or the equivalent Use a cable / connector of 50Ω impedance.
7.2	Withstand Voltage	Products shall not be damaged.	Voltage: Rated Voltage×250% (ref.item 10) Time:1~5s Measuring current: 10mA max.
7.3	Insulation Resistance (I.R.)	Meet item 3	Voltage: Rated Voltage (ref.item 10) Time: 30s max. Measuring current: 10mA max Measuring Equipment: KEYSIGHT 4339A or the equivalent
7.4	DC Resistance (Rdc)	Meet item 3	Measuring method: four-terminal method (ref.item 10)
7.5	Inductance (L)	Meet item 3	Measuring Frequency:1±0.1kHz (ref.item 10) Voltage: 1V (rms) max. Measuring Equipment: KEYSIGHT 4284A or the equivalent

8. Mechanical performance

	nechanical performance						
Νo.	Item	Spe	cification	Test Method			
8.1	Appearance and Dimensions	Meet Item 5		Visual Inspection and measured with Slide Calipers.			
8.2	Marking	Marking is able (ref.item 5)	to be read.	Visual Inspection			
8.3	Solderability	The electrodes shall be at least 90% covered with new solder coating.		Flux: Ethanol solution of rosin,25(wt)% Solder: Sn-3.0Ag-0.5Cu Pre-heating: 150°C±10°C, 60s Solder Temperature: 245°C±5°C Immersion Time: 3s±1s			
8.4	Resistance to soldering	Table 1 Appearance	No damage	Solder: Sn-3.0Ag-0.5Cu Pre-heating: 150°C~180°C, 90s±30s			
	heat (Reflow)	Inductance change	within ±15%	Peak: 270°C±5°C, 10s Reflow times: 1 time			
8.5	Vibration	(% ΔL) Insulation Resistance (I.R.) Withstand Voltage	Meet item 3 Products shall not be damaged.	It shall be soldered on the substrate. Oscillation Frequency: 10Hz to 2000Hz to 10Hz for 20 min Total Amplitude: 3.0mm or Acceleration amplitude 196 m / s² whichever is smaller. Testing Time: A period of 4 hours in each of 3 mutually perpendicular directions. (Total 12 h)			



9. Environmental Performance

It shall be soldered on the substrate.

No.	item	specification		test method
9.1	heat shock	Meet Table 2 Table 2 Appearance	No damage	1 cycle: 1 step: -55 °C(+0 °C,-3 °C) / 30min(+3min,-0min) 2 step: 125 °C (+3°C,-0 °C) / 30min(+3min,-0min) Total of 100 cycles
9.2	Humidity	Inductance change (% \(\Delta \L \)	Within ±20%	Then measured after exposure in the room condition for 48h± 4h. Temperature: 85°C±2°C
	life	Insulation Resistance (I.R.)	Meet item 3	Humidity: 80~85%(RH) Voltage: Rated Voltage Time: 1000+48/-0 h
		Withstand Voltage	Products shall not be damaged.	Then measured after exposure in the room condition for 48±4 h
9.3	Heat life			125°C ±2 °C Voltage: Rated Voltage×200% Time: 1000+48/-0h Then measured after exposure in the room condition for 48±4 h

10. Measuring Terminal

(When measuring and suppling the voltage, the following terminal is applied.)

No.	Item	Measuring terminal
10.1	Inductance (L) DC Resistance (Rdc)	INO
10.2	Withstand voltage Insulation Resistance (I.R.) Humidity life Heat life	IN OUTO
10.3	Common Mode Impedance(Zc)	INOOUT

11. Measuring method for common mode impedance.

Measured common mode impedance may be included measurement error due to stray capacitance, residual inductance of test fixture.

To correct this error, the common mode impedance should be calculate as follows;

- (1) Measure admittance of the fixture(opened), Go Bo.
- (2) Measure impedance of the fixture(shorted), Rs Xs.
- (3) Measure admittance of the specimen, Gm Bm.
- (4) Calculate corrected impedance | Z | using the formula below.

$$|Z| = (Rx^{2}+Xx^{2})^{1/2}$$
Where
$$Rx = \frac{Gm - Go}{(Gm-Go)^{2} + (Bm-Bo)^{2}} - Rs$$

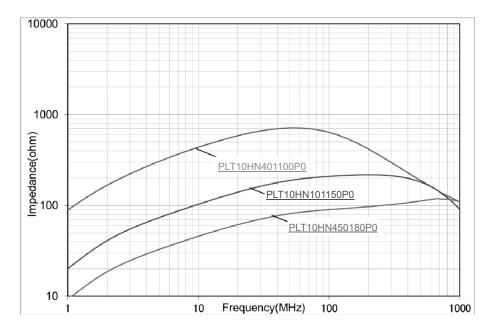
$$Xx = \frac{-(Bm - Bo)}{(Gm-Go)^{2} + (Bm-Bo)^{2}} - Xs$$

12. P.C.B., Flux, Solder and Soldering condition

Test shall be done using P.C.B., Flux, Solder and Soldering condition which are specified in item 16 except the case of being specified special condition.



13. Common Mode Impedance (Zc) frequency characteristics (typical)



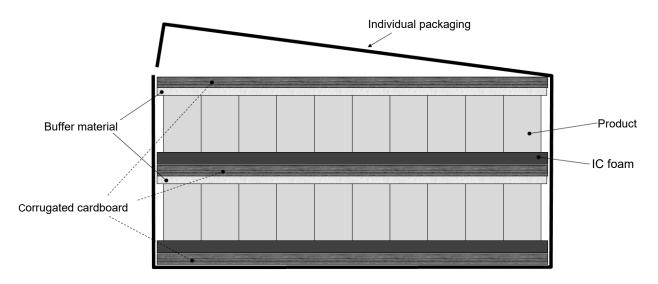
14. Specification of Packaging

14.1 Packing Quantity

Individual packaging	
100pcs	

14.2. Packing Method

IC foam of the stuck products on are placed in an Individual packaging. A quantity in an Outer packaging is depending on a quantity of an order.



In some cases, omit the Buffer material and/or Currugated cardboard.



14.3 Marking of packaging

(1) Individual packaing

The following items shall be marked on a label and the label is stuck on the Individual packaing. Customer part number, MURATA part number, Inspection number(*1), RoHS discrimination(*

*1) « Expression of Inspection No. »

 $\begin{array}{c|c} \square \square & OOOO & \times \times \times \\ \hline (1) & (2) & (3) \end{array}$

(1) Factory Code

(2) Date First digit : Year / Last digit of year

Second digit : Month / Jan. to Sep. → 1 to 9, Oct. to Dec. → O,N,D

Third, Fourth digit: Day

(3) Serial No.

*2) « Expression of RoHS discrimination » ROHS – \underline{Y} ($\underline{\Delta}$)

(1)(2)

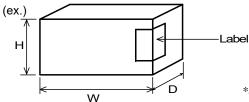
(1) RoHS regulation conformity parts.

(2) MURATA classification number

(2) Marking for Outside package

The following items shall be marked on a label and the label is stuck on the outside package. Customer name, Purchasing Order Number, Customer Part Number, MURATA part number, RoHS discrimination(*2), Quantity, etc

14.4 Specification of Outer Case



Outer C	ase Dim	ensions	Standard Individual
(mm)			package Quantity
W	D	Н	in Outer Case
265	89	118	5

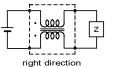
*Above Outer Case size is typical. It depends on a quantity of an order.

15.1 Mounting Direction

Mount products in right direction.

Wrong direction which is 90° rotated from right direction causes not only open or short circuit but also flames or

other serious trouble.



wrong direction

15.2 Fail Safe

Be sure to provide an appropriate fail-safe function on your product to prevent from a second damage that may be caused by the abnormal function or the failure of our products.

15.3 Limitation of Applications

Please contact us before using our products for the applications listed below which require especially high reliability for the prevention of defects which might directly cause damage to the third party's life, body or property.

(1) Aircraft equipment

(6) Transportation equipment (automobiles, trains, ships, etc.)

(2) Aerospace equipment

(7) Traffic signal equipment

(3)Undersea equipment

(8) Disaster prevention / crime prevention equipment

(4)Power plant control equipment

(9) Data-processing equipment

(5) Medical equipment

(10) Applications of similar complexity and /or reliability requirements to the applications listed in the above

15.4 Attention regarding product's heat generation

Please pay special attention to the product's heat generation such as beyond Operating Temperature range, mounting product in close proximity to other products that radiate heat and beyond the rated current.

15.5 Corrosive gas

Please refrain from use since contact with environments with corrosive gases (sulfur gas [hydrogen sulfide, sulfur dioxide, etc.], chlorine, ammonia, etc.) or oils (cutting oil, silicone oil, etc.) that have come into contact with the previously stated corrosive gas environment will result in deterioration of product quality or an open from deterioration due to corrosion of product electrode, etc. We will not bear any responsibility for use under these environments.

Spec No. JFL243B-0007C-01



16. Notice

Products can only be soldered with reflow.

This product is designed for solder mounting.

Please consult us in advance for applying other mounting method such as conductive adhesive.

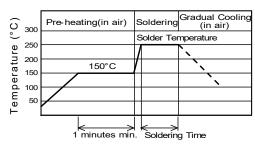
16.1 Flux and Solder

	Use rosin-based flux.Do not use highly acidic flux (with chlorine content exceeding0.2(wt)%) Do not use water soluble flux.
Solder	Use Sn-3.0Ag-0.5Cu solder

Other flux (except above) please contacts us for details, then use.

16.2 Soldering

(1) Standard flow soldering profile.



Solder	Soldering
Temperature	Time
250 ~ 260 °C	4 ~ 6 s

- (2) Resistance to soldering iron goes in the following condition that tip temperature is 350 °C max. and soldering time is 5 s max.
- (3) Products and the leads should not be subjected to any mechanical stress during soldering process. (and also while subjected to the equivalent high temperature.)

(1)Solder paste printing for reflow soldering

· Standard thickness of solder paste should be 150 to 200 µm.

Incidentally, depending on the reflow condition and the way of heat conduction, the solder would not wet up the terminal, being possible to lead to not enough connection between terminals and lands on the circuit board / open circuit in the circuit board. In case of use, always evaluate this part in your products with actual use condition.

- · For the solder paste printing pattern, use standard land dimensions.
- · For the resist and copper foil pattern, use standard land dimensions.
- · Use Sn-3.0Ag-0.5Cu solder

16.3 Cleaning Conditions

Products shall be cleaned on the following conditions.

- (1) Cleaning temperature shall be limited to 60 °C max. (40 °C max. for IPA.)
- (2) Ultrasonic cleaning shall comply with the following conditions, with avoiding the resonance phenomenon at the mounted products and P.C.B.

Power: 20W / I max. Frequency: 28kHz to 40kHz Time: 5 minutes max.

- (3) Cleaner
 - 1.Cleaner
 - · Isopropyl alcohol (IPA)
 - 2.Aqueous agent
 - · Higher Alcohol Type (PINE ALPHA ST-100S)
- (4) There shall be no residual flux and residual cleaner after cleaning.

In the case of using aqueous agent, products shall be dried completely after rinse with de-ionized water in order to remove the cleaner.

- (5) The surface of products may become dirty whitely after cleaning.
 - But there is no deterioration on mechanical, electrical characteristics and reliability.
- (6) Other cleaning
 - Please contact us.

16.4 Operating Environment

Do not use this product under the following environmental conditions, on deterioration of the Insulation Resistance and/or corrosion of Inner Electrode may result from the use.

- (1) In the corrodible atmosphere (acidic gas, alkaline gas, chlorine, sulfur gas, organic gas and etc.)
- (2) In the atmosphere where liquid such as organic solvent, may splash on the products.
- (3) In the atmosphere where the temperature / humidity changes rapidly and it is easy to dew.
- (4) In the atmosphere where the product is covered with dust or is subjected to salty breeze.



16.5 Storage Conditions

(1)Storage period

Use the products within 12 months after delivered.

Solderability should be checked if this period is exceeded.

(2)Storage conditions

• Products should be stored in the warehouse on the following conditions.

Temperature: -10°C to 40°C

Humidity: 15% to 85% relative humidity

No rapid change on temperature and humidity

- Don't keep products in corrosive gases such as sulfur, chlorine gas or acid, or it may cause oxidization of electrode, resulting in poor solderability.
- Products should be stored on the palette for the prevention of the influence from humidity, dust and so on.
- Products should be stored in the warehouse without heat shock, vibration, direct sunlight and so on.
- Avoid storing the product by itself bare (i.e.exposed directly to air).

(3)Delivery

Care should be taken when transporting or handling product to avoid excessive vibration or mechanical shock.

17. A Note

- (1)Please make sure that your product has been evaluated in view of your specifications with our product being mounted to your product.
- (2) You are requested not to use our product deviating from the reference specifications.
- (3)The contents of this reference specification are subject to change without advance notice.

Please approve our product specifications or transact the approval sheet for product specifications before ordering.